# Chapter 1

## Introduction

The future upgrade of the Large Hadron Collider (LHC) accelerator, the Super Large Hadron Collider (SLHC), will increase the beam luminosity leading to a corresponding growth of the amount of data to be treated by the data acquisition systems. This will thus require high rate data links and high radiation tolerant Application Specific Integrated Circuits (ASICs).

To address these needs, the Gigabit Transceiver (GBT) architecture and transmission protocol was developed to provide the simultaneous transfer of readout data, timing and trigger signals in addition to slow control and monitoring data. The GBT system consists of

The GBT system can be described in two parts: The on-detector part and the off-detector part of the system. The on-detector part consists of radiation hard GBT ASICs that will act as detectors and will thus be located in the radioactive zone. These ASICs are used to implement bidirectional multipurpose  $4.8~\mathrm{Gbit/s}$  optical links for the high-energy physics experiments.

The off-detector part is located in the counting room and consists of the Common Readout Unit (CRU) that will provide an interface between the detector ASIC and an online computerfarm. The CRU consists of Commercial Off-The-Shelf (COTS) components (mainly an FPGA), and will through optical links receive the data from the radiation detector.

This thesis has its focus on the design of the CRU control interface and the physical connection between the CRU and the Versatile Link Demonstrator Board (VLDB) card, where the radiation hard ASIC, the GBTx, is located.

## 1.1 Altera's Cyclone V GT

The Field-Programmable Gate Array (FPGA) used in this thesis is the Cyclone V GT by Altera. GT indicates that the FPGA has transceivers that supports speeds up to  $6~{\rm Gbit/s}$ 

[? ]. It was chosen for this thesis mainly because of the on-board transceivers that are capable of reaching speeds that surpass the requirements of the GBT-FPGA Multi-Gigabit Transceiver (MGT), i.e  $4.8~\rm Gbit/s$ . Originally, a Terasic Cyclone V GX development board was handed for use with this thesis. The Terasic board has advantages over the Cyclone V GT board in terms of communication with the outside world such as on-board Usb-to-Uart (more on this in chapter ??). However, it was discovered that the transceivers on the Terasic board were not fast enough for the GBT MGT; maximum supported transceiver speed is only  $3.125~\rm Gbit/s$  [? ]. Because of this, the more powerful Cyclone V GT FPGA development board was ordered from the Altera web-pages, replacing the Terasic.

## 1.2 Cyclone V Transceiver Technology

To be able to send serial data in the gigahertz domain, a high-speed transceiver is required. The Cyclone V GT-series FPGAs supports a number of transceiver technologies through the High-Speed Mezzanine Card (HSMC) physical interface that can reach speeds up to  $6.144~\rm Gbit/s$ . This section gives a general description of some of these protocols.

### 1.2.1 Differential Signals

Common for all protocols described is the fact that the signals are treated differentially. While a single ended signal involves one conductor between the transmitter and receiver, with the signal swinging from a given voltage to ground; differential signals involves a conductor pair with two signals that are identical, but with opposite polarity. The pair would ideally have equal path lengths in order to have zero return currents, avoiding problems like *EMI*. In addition, placing the signals as close as possible to one another will give benefits in terms of common noise rejection [?].

When done correctly, differential signals have advantages over single ended signals such as effective isolation from power systems, minimized crosstalk and noise immunity through common-mode noise rejection. It also improves S/N ratio and effectively doubles the signal level at the output (+v-(-v)=2v), which makes it especially useful in low signal applications. The disadvantage comes in an increase in pin count and space required, since differential signals consists of two wires instead of one [?].

## 1.2.2 Low-Voltage Differential Signaling

Low-Voltage Differential Signaling (LVDS) is said to be the most commonly used differential interface. The interface offers a low power consumption with a voltage swing of  $350 \,\mathrm{mV}$  and good noise immunity. LVDS can deliver data rates up to  $3.125 \,\mathrm{Gbit/s}$  [?].

The Cyclone V GT board has 17 LVDS channels available on the HSMC port A connector. The channels have the ability to transmit and receive data at a rate up to  $840~\mathrm{Mbit/s}$ , with support for serialization and deserialization through internal logic. [?]

### 1.2.3 Current-Mode Logic

For data rates that exceeds  $3.125~\mathrm{Gbit/s}$ , Current-Mode Logic (CML) signaling is preferred. This is due to the fact that certain communication standards such as PCIe, SATA and HDMI, shares consistency with CML in signal amplitude and reference to Vcc. CML can reach a data rate in excess of  $10~\mathrm{Gbit/s}$ , but has a higher power consumption than LVDS, with a voltage swing of approximately  $800~\mathrm{mV}$  [?].

The Cyclone V GT board has 4 Pseudo-CML (PCML) channels available on both port A and B HSMC connectors. The channels have the ability to transmit and receive data at a rate up to 5.0 Gbit/s, just over the 4.8 Gbit/s range required by the GBT MGT. [?]

# **Chapter 2**

# The Gigabit Transceiver

Short about the electron components gbt-sca, gbt:

## 2.1 Encoding modes

The "GBT-Frame" mode, which is Reed-Solomon Based; the "8b10b" mode; and the "Wide-Bus" mode which is without encoding.

### 2.2 GBT-FPGA Core

The following sections describe the different components that makes up the GBT-FPGA Core. The information was obtained by reading the GBT-FPGA User Guide [?].

### 2.2.1 GBT Bank

The GBT Bank is defined as the top module of the GBT-FPGA Core. It integrates up to four GBT Links and contains the ports required to operate the GBT Links.

#### 2.2.2 GBT Link

The GBT Link is the actual channel of the link. It is composed of three components: GBT Tx, GBT Rx, and the MGT. The following subsections gives a brief description of these components.

#### **GBT Tx**

The GBT Tx component is responsible for scrambling and encoding data before transmitting it through the MGT.

#### **GBT Rx**

The GBT Rx component is responsible for receiving, decoding and de-scrambling the data through the MGT.

### **Multi-Gigabit Transceiver**

The MGT is responsible for the transmitting, receiving, serialization and de-serialization of the GBT data. It is divided into a transmitter and a receiver part.

The transmitter contains a PISO with two input clocks; one for parallel data and one for serial data. It shifts in 40 bit words from the GBT Tx with a reference clock of 120 MHz, serializes the data and sends it out with the help of a dedicated Tx Phase-Locked Loop (PLL) that generates a serial clock of  $2400 \mathrm{MHz}$ .

The receiver contains a Clock & Data Recovery (CDR) block, a SIPO, a RXRECCLK Phase Aligner block and a Barrel-shifter.